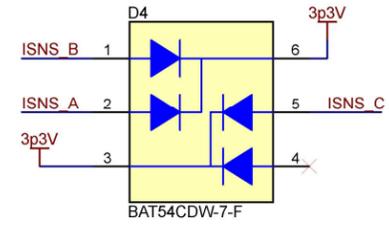
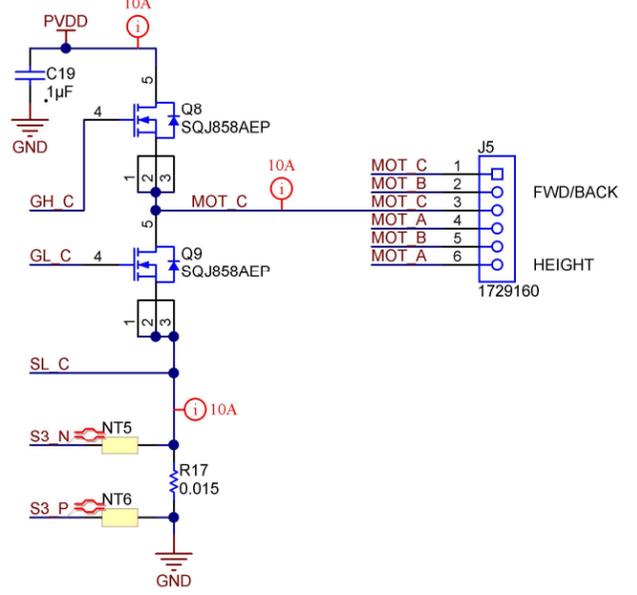
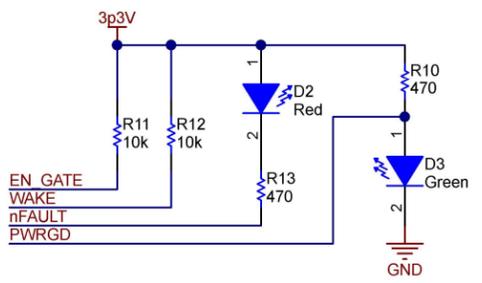
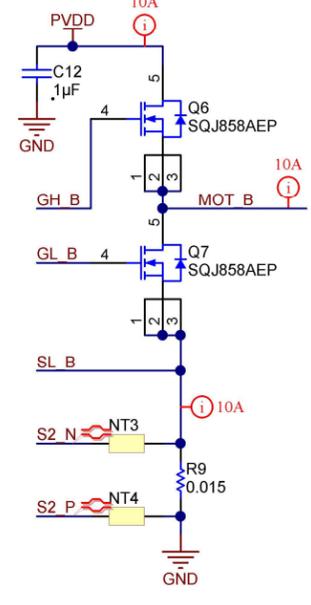
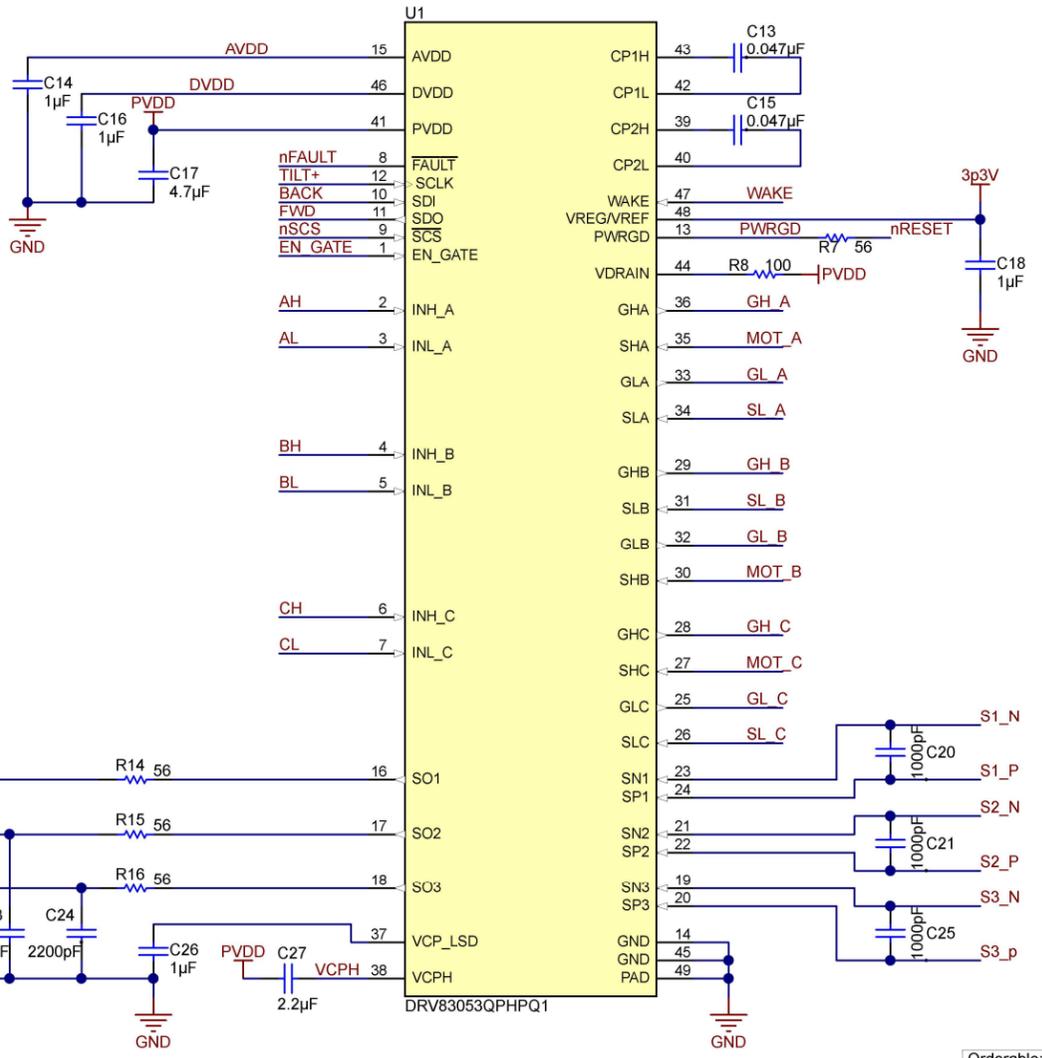


This board is intended for use with the MSP430G2 LaunchPad with MSP430G2553



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